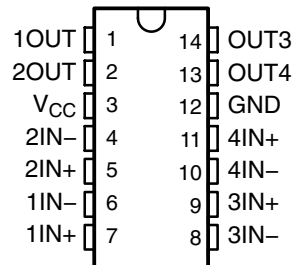


# LM239A-Q1 QUAD DIFFERENTIAL COMPARATOR

SCLS513B – JULY 2003 – REVISED FEBRUARY 2008

- Qualified for Automotive Applications
- ESD Protection Exceeds 1000 V Per MIL-STD-883, Method 3015; Exceeds 100 V Using Machine Model (C = 200 pF, R = 0); Exceeds 2000 V Charged Device Model
- Single Supply or Dual Supplies
- Wide Range of Supply Voltage . . . 2 V to 36 V
- Low Supply-Current Drain Independent of Supply Voltage . . . 0.8 mA Typ
- Low Input Bias Current . . . 25 nA Typ
- Low Input Offset Current . . . 5 nA Typ
- Low Input Offset Voltage . . . 2 mV Typ
- Common-Mode Input Voltage Range Includes Ground
- Differential Input Voltage Range Equal to Maximum-Rated Supply Voltage . . .  $\pm 36$  V
- Low Output Saturation Voltage
- Output Compatible With TTL, MOS, and CMOS

**D PACKAGE  
(TOP VIEW)**



## description/ordering information

This device consists of four independent voltage comparators that are designed to operate from a single power supply over a wide range of voltages. Operation from dual supplies also is possible as long as the difference between the two supplies is 2 V to 36 V, and  $V_{CC}$  is at least 1.5 V more positive than the input common-mode voltage. Current drain is independent of the supply voltage. The outputs can be connected to other open-collector outputs to achieve wired-AND relationships.

## ORDERING INFORMATION†

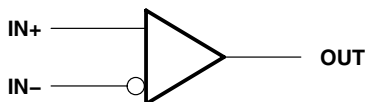
$T_A$	PACKAGE‡		ORDERABLE PART NUMBER	TOP-SIDE MARKING
-40°C to 125°C	SOP – D	Tape and reel	LM239AQDRQ1§	LM239AQ1

† For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at <http://www.ti.com>.

‡ Package drawings, thermal data, and symbolization are available at <http://www.ti.com/packaging>.

§ This package is only available taped and reeled, with standard quantities of 2500 pieces per reel.

## symbol (each comparator)



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS  
INSTRUMENTS**

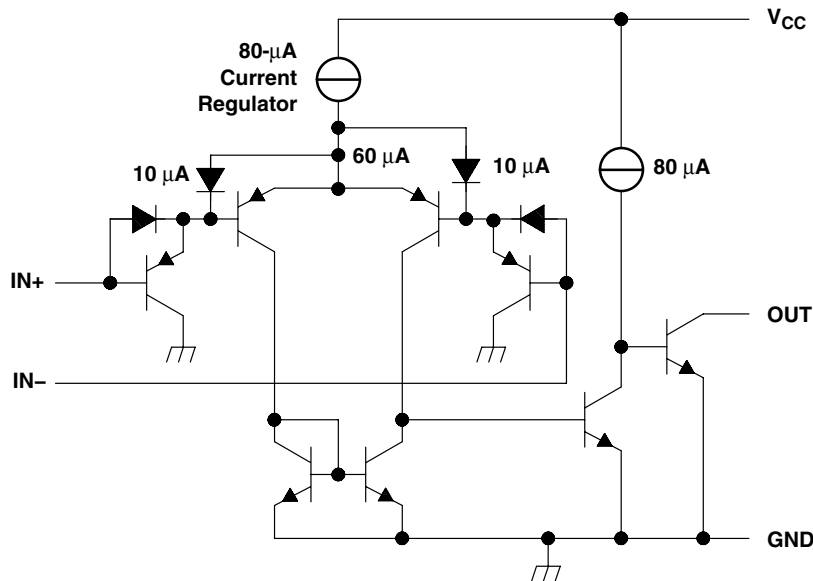
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LM239A-Q1  
QUAD DIFFERENTIAL COMPARATOR

SCLS513B – JULY 2003 – REVISED FEBRUARY 2008

schematic (each comparator)



All current values shown are nominal.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage, $V_{CC}$ (see Note 1)	36 V
Differential input voltage, $V_{ID}$ (see Note 2)	$\pm 36$ V
Input voltage range, $V_I$ (either input)	-0.3 V to 36 V
Output voltage, $V_O$	36 V
Output current, $I_O$	20 mA
Duration of output short circuit to ground (see Note 3)	Unlimited
Package thermal impedance, $\theta_{JA}$ (see Note 4)	86°C/W
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C
Maximum operating junction temperature, $T_J$	136°C
Storage temperature range, $T_{stg}$	-65°C to 150°C

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
1. All voltage values, except differential voltages, are with respect to network ground.
  2. Differential voltages are at IN+ with respect to IN-.
  3. Short circuits from outputs to  $V_{CC}$  can cause excessive heating and eventual destruction.
  4. The package thermal impedance is calculated in accordance with JESD 51-7.

# LM239A-Q1

## QUAD DIFFERENTIAL COMPARATOR

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electrical characteristics at specified free-air temperature,  $V_{CC} = 5\text{ V}$  (unless otherwise noted)

PARAMETER		TEST CONDITIONS†		T <sub>A</sub> ‡	MIN	TYP	MAX	UNIT
V <sub>IO</sub>	Input offset voltage	V <sub>CC</sub> = 5 V to 30 V, V <sub>IC</sub> = V <sub>ICR</sub> (min), V <sub>O</sub> = 1.4 V		25°C		1	2.5	mV
				Full range			5.5	
I <sub>IO</sub>	Input offset current	V <sub>O</sub> = 1.4 V		25°C		5	50	nA
				Full range			150	
I <sub>IB</sub>	Input bias current	V <sub>O</sub> = 1.4 V		25°C		–25	–250	nA
				Full range			–400	
V <sub>ICR</sub>	Common-mode input-voltage range			25°C		0 to V <sub>CC</sub> –1.5		V
				Full range		0 to V <sub>CC</sub> –2		
A <sub>VD</sub>	Large-signal differential-voltage amplification	V <sub>CC</sub> = 15 V, V <sub>O</sub> = 1.4 V to 11.4 V, R <sub>L</sub> ≥ 15 kΩ to V <sub>CC</sub>		25°C		50	200	V/mV
I <sub>OH</sub>	High-level output current	V <sub>ID</sub> = 1 V	V <sub>OH</sub> = 5 V	25°C		0.1	50	nA
			V <sub>OH</sub> = 30 V	Full range			1	μA
V <sub>OL</sub>	Low-level output voltage	V <sub>ID</sub> = –1 V, I <sub>OL</sub> = 4 mA	25°C			150	400	mV
			Full range				700	
I <sub>OL</sub>	Low-level output current	V <sub>ID</sub> = –1 V, V <sub>OL</sub> = 1.5 V	25°C		6	16		mA
I <sub>CC</sub>	Supply current (four comparators)	V <sub>O</sub> = 2.5 V, No load	25°C			0.8	2	mA

† All characteristics are measured with zero common-mode input voltage, unless otherwise specified.

‡ Full range (MIN to MAX) for LM239AQ is –40°C to 125°C. All characteristics are measured with zero common-mode input voltage, unless otherwise specified.

switching characteristics,  $V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Response time	$R_L$ connected to 5 V through 5.1 k $\Omega$ , $C_L = 15\text{ pF}$ §, See Note 5	100-mV input step with 5-mV overdrive		1.3	$\mu\text{s}$
		TTL-level input step		0.3	

§  $C_L$  includes probe and jig capacitance.

NOTE 5: The response time specified is the interval between the input step function and the instant when the output crosses 1.4 V.



## PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
LM239AQDRG4Q1	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	LM239AQ1	<a href="#">Samples</a>
LM239AQDRQ1	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	LM239AQ1	<a href="#">Samples</a>

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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**OTHER QUALIFIED VERSIONS OF LM239A-Q1 :**

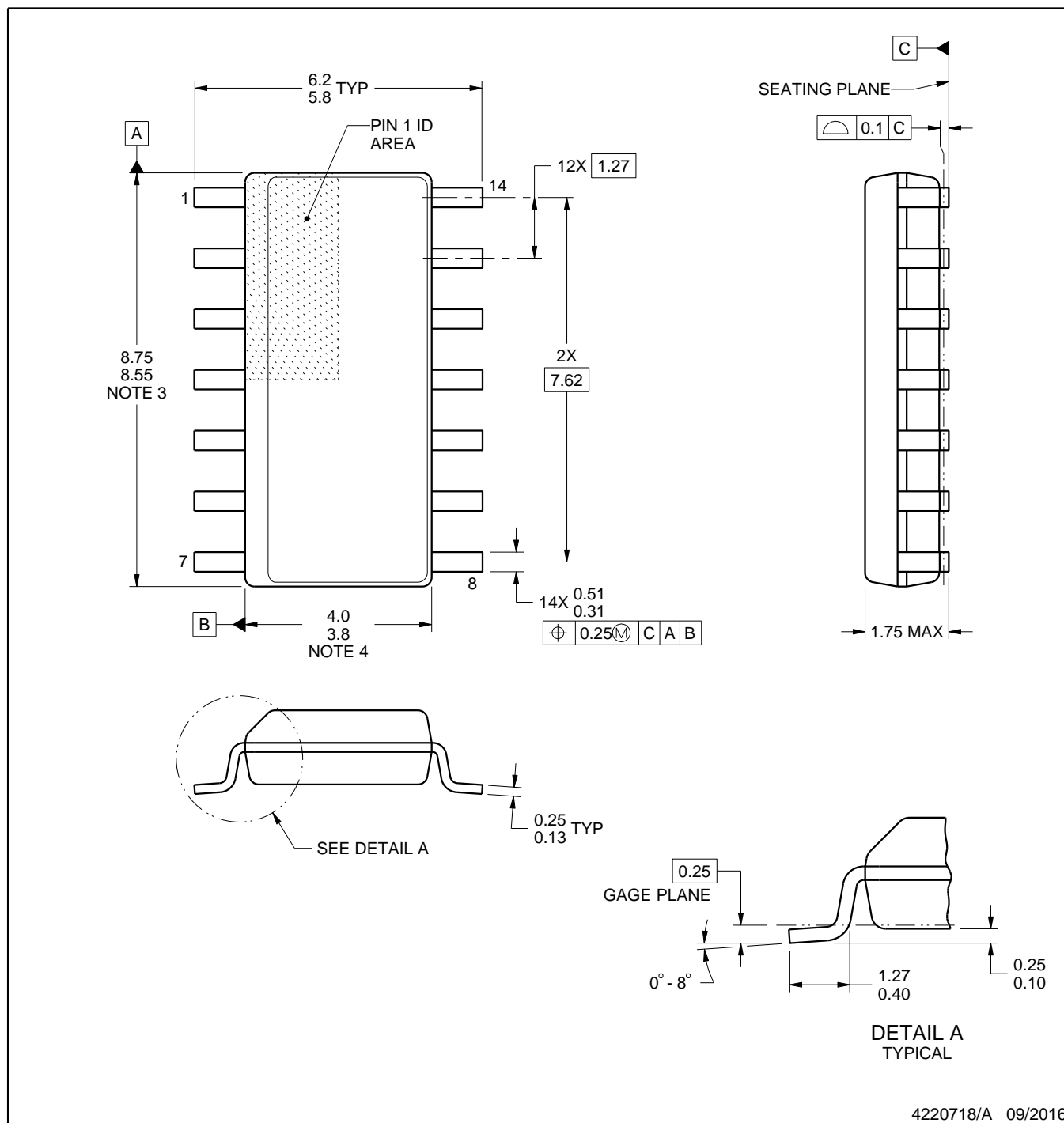
- Catalog: [LM239A](#)
- Enhanced Product: [LM239A-EP](#)

**NOTE:** Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Enhanced Product - Supports Defense, Aerospace and Medical Applications

**D0014A****PACKAGE OUTLINE****SOIC - 1.75 mm max height**

SMALL OUTLINE INTEGRATED CIRCUIT



4220718/A 09/2016

**NOTES:**

1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm, per side.
5. Reference JEDEC registration MS-012, variation AB.

# EXAMPLE BOARD LAYOUT

D0014A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



LAND PATTERN EXAMPLE  
SCALE:8X



SOLDER MASK DETAILS

4220718/A 09/2016

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

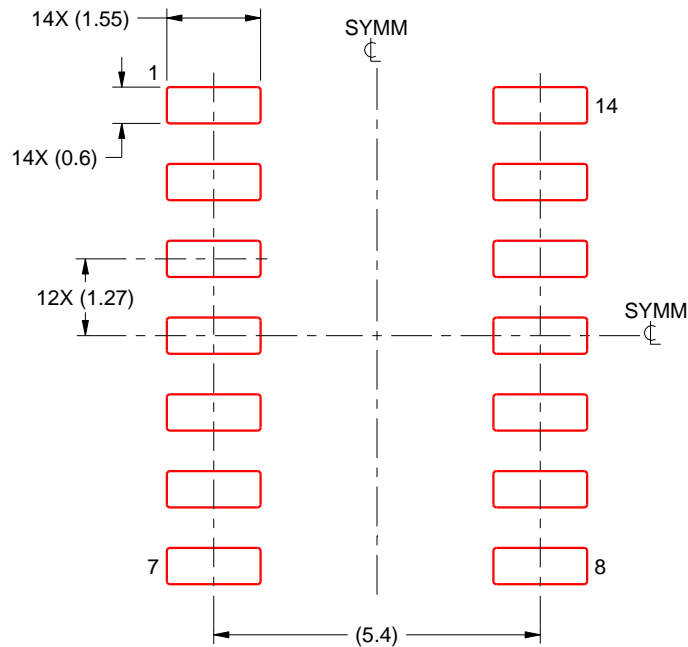
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

D0014A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:8X

4220718/A 09/2016

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.



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